

Special Issue

Advances in Intelligent Systems

Message from the Guest Editors

This Special Issue invites state-of-the-art research in intelligent systems. It will also include selected papers from the conference of the 22nd International Symposium on Advanced Intelligent Systems (ISIS 2021, <http://isis2021.org/>), which will be held at CheongJu, South Korea on 15–18 December 2021. The topics of the contributed papers will include various intelligent techniques and their real-world applications. Keywords

- computational intelligence
- machine learning
- fuzzy logic and reasoning
- evolutionary algorithms
- soft computing
- data mining
- big data analysis
- probabilistic models and inference
- robotics
- image processing
- (bio)medical applications

Guest Editors

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Deadline for manuscript submissions

closed (30 April 2022)



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About the Journal

Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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